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What is "[Embedded - Microcontrollers](#)"?

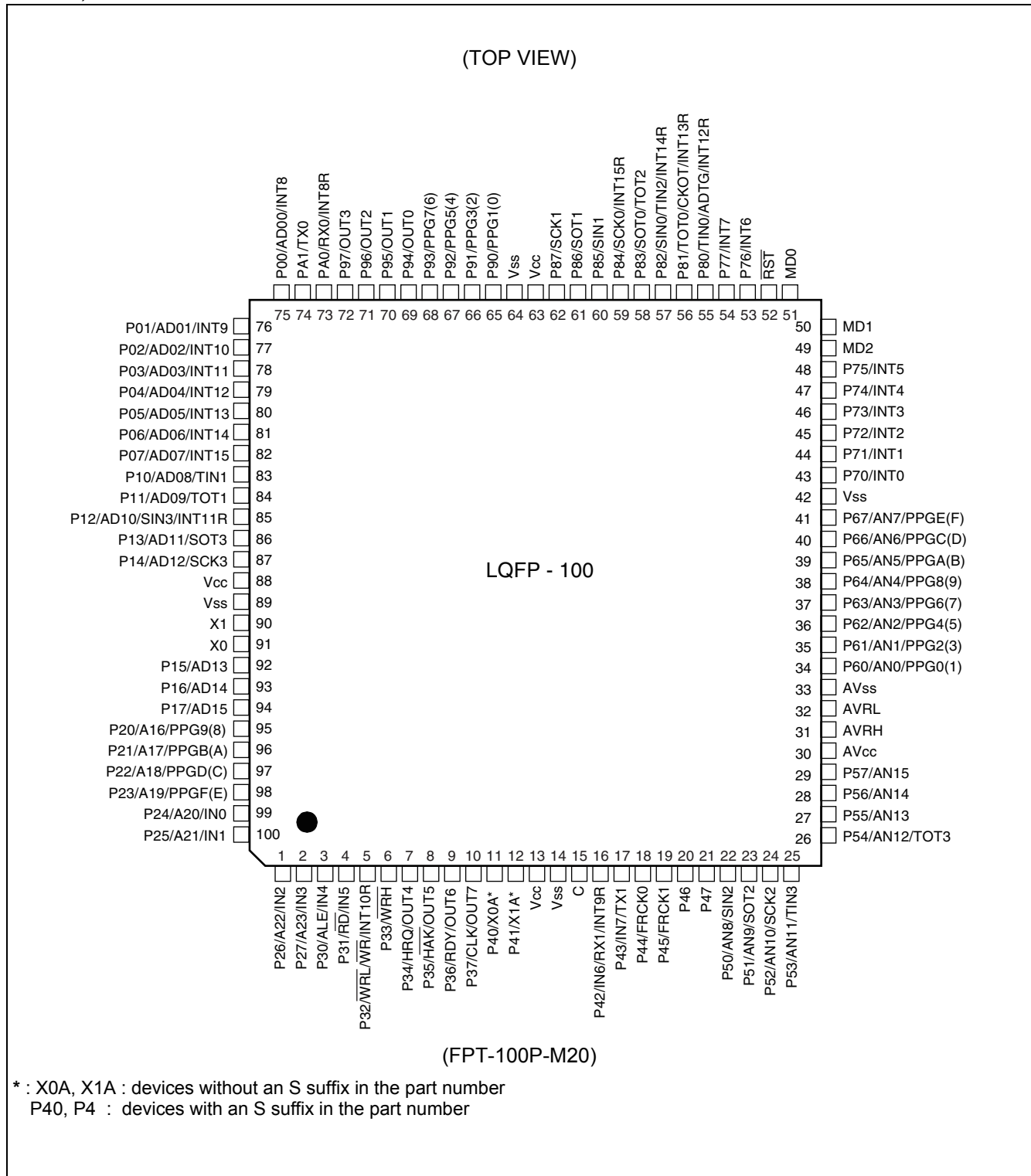
"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

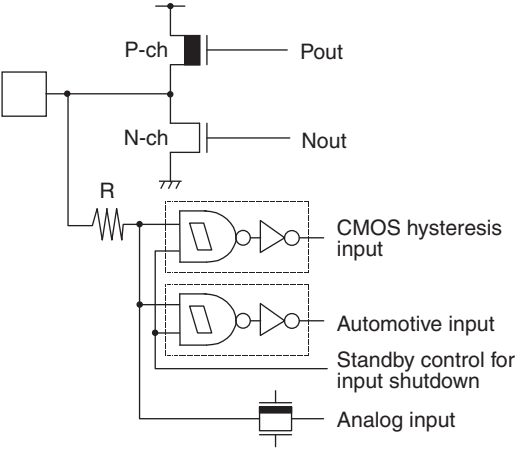
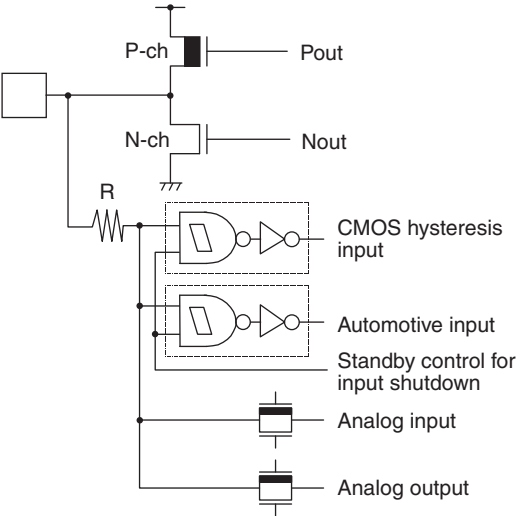
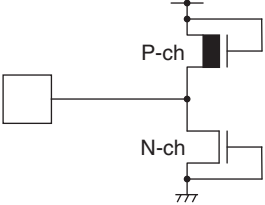
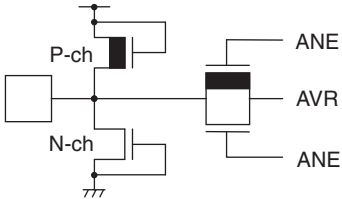
Product Status	Obsolete
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	24MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, UART/USART
Peripherals	DMA, POR, WDT
Number of I/O	80
Program Memory Size	256KB (256K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	3.5V ~ 5.5V
Data Converters	A/D 24x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90349cepf-g-352e1

(Continued)



Pin No.		Pin name	I/O Circuit type*3	Function
QFP100*1	LQFP100*2			
19	17	P43	F	General purpose I/O pin.
		IN7		Trigger input pin for input capture.
		TX1		TX Output pin for CAN1 (MB90341E/342E/F342E/F345E only)
20	18	P44	H	General purpose I/O pin.
		SDA0		Serial data I/O pin for I ² C (devices with a C suffix in the part number)
		FRCK0		Input pin for the 16-bit Free-run Timer 0
21	19	P45	H	General purpose I/O pin.
		SCL0		Serial clock I/O pin for I ² C (devices with a C suffix in the part number)
		FRCK1		Input pin for the 16-bit Free-run Timer
22	20	P46	H	General purpose I/O pin.
		SDA1		Serial data I/O pin for I ² C (devices with a C suffix in the part number)
23	21	P47	H	General purpose I/O pin.
		SCL1		Serial clock I/O pin for I ² C (devices with a C suffix in the part number)
24	22	P50	O	General purpose I/O pin.
		AN8		Analog input pin for the A/D converter
		SIN2		Serial data input pin for UART2
25	23	P51	I	General purpose I/O pin.
		AN9		Analog input pin for the A/D converter
		SOT2		Serial data output pin for UART2
26	24	P52	I	General purpose I/O pin.
		AN10		Analog input pin for the A/D converter
		SCK2		Clock I/O pin for UART2
27	25	P53	I	General purpose I/O pin.
		AN11		Analog input pin for the A/D converter
		TIN3		Event input pin for the reload timer
28	26	P54	I	General purpose I/O pin.
		AN12		Analog input pin for the A/D converter
		TOT3		Output pin for the reload timer
29	27	P55	I	General purpose I/O pin.
		AN13		Analog input pin for the A/D converter
30, 31	28, 29	P56, P57	J	General purpose I/O pins.
		AN14, AN15		Analog input pins for the A/D converter
32	30	AV _{CC}	K	Analog power input pin for the A/D Converter

(Continued)

Type	Circuit	Remarks
I		■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input
J		■ CMOS level output ($I_{OL} = 4 \text{ mA}$, $I_{OH} = -4 \text{ mA}$) ■ D/A analog output ■ CMOS hysteresis input (with function to disconnect input during standby) ■ Automotive input (with function to disconnect input during standby) ■ A/D converter analog input
K		Power supply input protection circuit
L		■ A/D converter reference voltage power supply input pin, with the protection circuit ■ Flash memory devices do not have a protection circuit against V_{CC} for pin AVRH

5. Handling Devices

1. Preventing latch-up

CMOS IC may suffer latch-up under the following conditions:

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between V_{CC} and V_{SS} pins.
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current drastically, causing thermal damage to the device.

For the same reason, also be careful not to let the analog power-supply voltage (AV_{CC} , AV_{RH}) exceed the digital power-supply voltage.

2. Handling unused pins

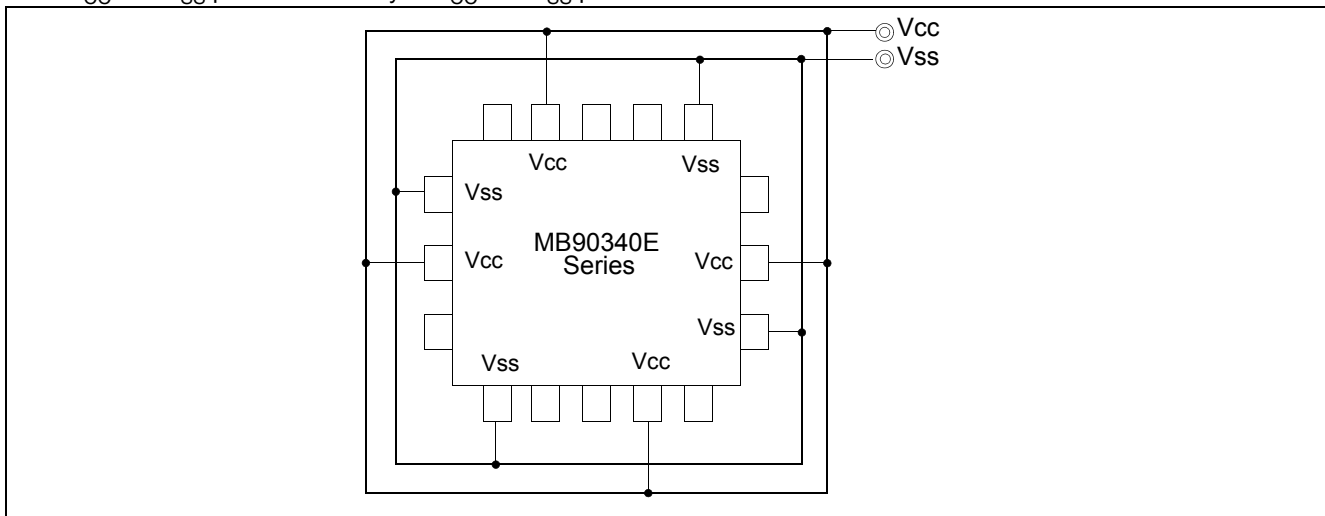
Leaving unused input terminals open may lead to permanent damage due to malfunction and latch-up; pull up or pull down the terminals through the resistors of 2 k Ω or more.

3. Power supply pins (V_{CC}/V_{SS})

- If there are multiple V_{CC} and V_{SS} pins, from the point of view of device design, pins to be of the same potential are connected inside of the device to prevent malfunction such as latch-up.

To reduce unnecessary radiation, prevent malfunctioning of the strobe signal due to the rise of ground level, and observe the standard for total output current, be sure to connect the V_{CC} and V_{SS} pins to the power supply and ground externally. Connect V_{CC} and V_{SS} pins to the device from the current supply source at a possibly low impedance.

- As a measure against power supply noise, it is recommended to connect a capacitor of about 0.1 μ F as a bypass capacitor between V_{CC} and V_{SS} pins in the vicinity of V_{CC} and V_{SS} pins of the device.

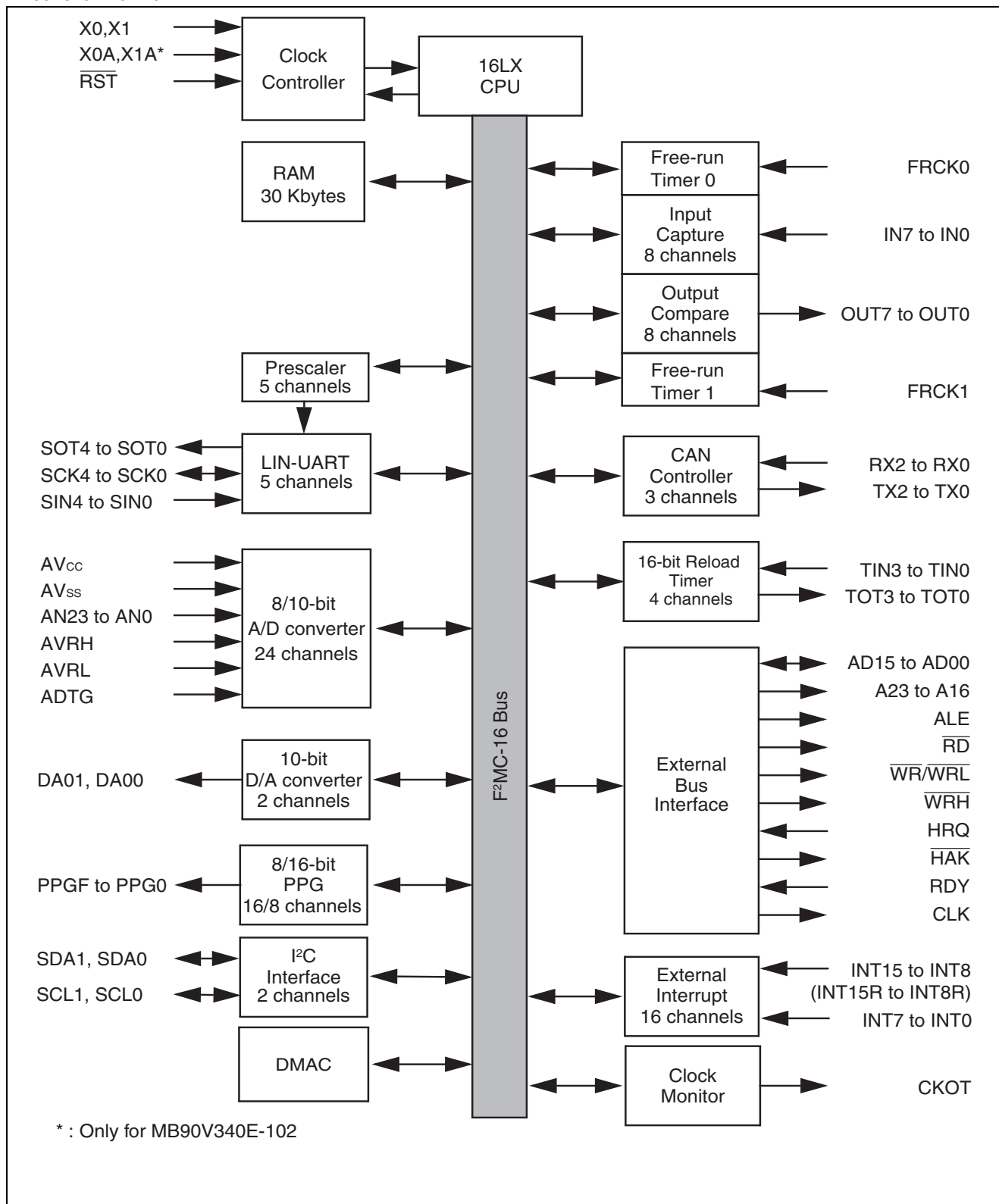


4. Mode Pins (MD0 to MD2)

Connect the mode pins directly to V_{CC} or V_{SS} pins. To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the mode pins to V_{CC} or V_{SS} pins and to provide a low-impedance connection.

6. Block Diagrams

■ MB90V340E-101/102



7. Memory Map

MB90V340E-101/102		MB90F345E(S)/F345CE(S)	
000000H	Peripheral	000000H	Peripheral
0000EFH	External access area	0000EFH	External access area
000100H	RAM 30 Kbytes	000100H	RAM 20 Kbytes
0078FFH	Peripheral	0050FFH	
007900H		007900H	
007FFFH	ROM (image of FF bank)	007FFFH	Peripheral
008000H		008000H	
00FFFFH	External access area	00FFFFH	ROM (image of FF bank)
F80000H	ROM (F8 bank)	F80000H	External access area
F8FFFFH	ROM (F9 bank)	F8FFFFH	ROM (F8 bank)
F90000H		F90000H	ROM (F9 bank)
F9FFFFH	ROM (FA bank)	F9FFFFH	ROM (F9 bank)
FA0000H		FA0000H	ROM (FA bank)
FAFFFFH	ROM (FB bank)	FAFFFFH	ROM (FA bank)
FB0000H		FB0000H	ROM (FB bank)
FBFFFFH	ROM (FC bank)	FBFFFFH	ROM (FB bank)
FC0000H		FC0000H	ROM (FC bank)
FCFFFFH	ROM (FD bank)	FCFFFFH	ROM (FC bank)
FD0000H		FD0000H	ROM (FD bank)
FDFFFFH	ROM (FE bank)	FDFFFFH	ROM (FD bank)
FE0000H		FE0000H	ROM (FE bank)
FEFFFFH	ROM (FF bank)	FEFFFFH	ROM (FE bank)
FF0000H		FF0000H	ROM (FF bank)
FFFFFFH	ROM (FF bank)	FFFFFFH	ROM (FF bank)

 : Not accessible

8. I/O Map

Address	Register	Abbreviation	Access	Resource name	Initial value
000000 _H	Port 0 Data Register	PDR0	R/W	Port 0	XXXXXXXX _B
000001 _H	Port 1 Data Register	PDR1	R/W	Port 1	XXXXXXXX _B
000002 _H	Port 2 Data Register	PDR2	R/W	Port 2	XXXXXXXX _B
000003 _H	Port 3 Data Register	PDR3	R/W	Port 3	XXXXXXXX _B
000004 _H	Port 4 Data Register	PDR4	R/W	Port 4	XXXXXXXX _B
000005 _H	Port 5 Data Register	PDR5	R/W	Port 5	XXXXXXXX _B
000006 _H	Port 6 Data Register	PDR6	R/W	Port 6	XXXXXXXX _B
000007 _H	Port 7 Data Register	PDR7	R/W	Port 7	XXXXXXXX _B
000008 _H	Port 8 Data Register	PDR8	R/W	Port 8	XXXXXXXX _B
000009 _H	Port 9 Data Register	PDR9	R/W	Port 9	XXXXXXXX _B
00000A _H	Port A Data Register	PDRA	R/W	Port A	XXXXXXXX _B
00000B _H	Port 5 Analog Input Enable Register	ADER5	R/W	Port 5, A/D	1111111 _B
00000C _H	Port 6 Analog Input Enable Register	ADER6	R/W	Port 6, A/D	1111111 _B
00000D _H	Port 7 Analog Input Enable Register	ADER7	R/W	Port 7, A/D	1111111 _B
00000E _H	Input Level Select Register 0	ILSR0	R/W	Ports	XXXXXXXX _B
00000F _H	Input Level Select Register 1	ILSR1	R/W	Ports	XXXX0XXX _B
000010 _H	Port 0 Direction Register	DDR0	R/W	Port 0	0000000 _B
000011 _H	Port 1 Direction Register	DDR1	R/W	Port 1	0000000 _B
000012 _H	Port 2 Direction Register	DDR2	R/W	Port 2	0000000 _B
000013 _H	Port 3 Direction Register	DDR3	R/W	Port 3	0000000 _B
000014 _H	Port 4 Direction Register	DDR4	R/W	Port 4	0000000 _B
000015 _H	Port 5 Direction Register	DDR5	R/W	Port 5	0000000 _B
000016 _H	Port 6 Direction Register	DDR6	R/W	Port 6	0000000 _B
000017 _H	Port 7 Direction Register	DDR7	R/W	Port 7	0000000 _B
000018 _H	Port 8 Direction Register	DDR8	R/W	Port 8	0000000 _B
000019 _H	Port 9 Direction Register	DDR9	R/W	Port 9	0000000 _B
00001A _H	Port A Direction Register	DDRA	R/W	Port A	00000100 _B
00001B _H	Reserved				
00001C _H	Port 0 Pull-up Control Register	PUCR0	R/W	Port 0	0000000 _B
00001D _H	Port 1 Pull-up Control Register	PUCR1	R/W	Port 1	0000000 _B
00001E _H	Port 2 Pull-up Control Register	PUCR2	R/W	Port 2	0000000 _B
00001F _H	Port 3 Pull-up Control Register	PUCR3	W, R/W	Port 3	0000000 _B

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
0000A5 _H	Automatic Ready Function Select Register	ARSR	W	External Memory Access	0011XX00 _B
0000A6 _H	External Address Output Control Register	HACR	W		00000000 _B
0000A7 _H	Bus Control Signal Selection Register	ECSR	W		0000000X _B
0000A8 _H	Watchdog Control Register	WDTC	R,W	Watchdog Timer	XXXXXX11 _B
0000A9 _H	Time Base Timer Control Register	TBTC	W,R/W	Time Base Timer	1XX00100 _B
0000AA _H	Watch Timer Control Register	WTC	R,R/W	Watch Timer	1X001000 _B
0000AB _H	Reserved				
0000AC _H	DMA Enable L Register	DERL	R/W	DMA	00000000 _B
0000AD _H	DMA Enable H Register	DERH	R/W		00000000 _B
0000AE _H	Flash Control Status Register (Flash memory devices only. Otherwise reserved)	FMCS	R,R/W	Flash Memory	000X0000 _B
0000AF _H	Reserved				
0000B0 _H	Interrupt Control Register 00	ICR00	W,R/W	Interrupt Control	00000111 _B
0000B1 _H	Interrupt Control Register 01	ICR01	W,R/W		00000111 _B
0000B2 _H	Interrupt Control Register 02	ICR02	W,R/W		00000111 _B
0000B3 _H	Interrupt Control Register 03	ICR03	W,R/W		00000111 _B
0000B4 _H	Interrupt Control Register 04	ICR04	W,R/W		00000111 _B
0000B5 _H	Interrupt Control Register 05	ICR05	W,R/W		00000111 _B
0000B6 _H	Interrupt Control Register 06	ICR06	W,R/W		00000111 _B
0000B7 _H	Interrupt Control Register 07	ICR07	W,R/W		00000111 _B
0000B8 _H	Interrupt Control Register 08	ICR08	W,R/W		00000111 _B
0000B9 _H	Interrupt Control Register 09	ICR09	W,R/W		00000111 _B
0000BA _H	Interrupt Control Register 10	ICR10	W,R/W		00000111 _B
0000BB _H	Interrupt Control Register 11	ICR11	W,R/W		00000111 _B
0000BC _H	Interrupt Control Register 12	ICR12	W,R/W		00000111 _B
0000BD _H	Interrupt Control Register 13	ICR13	W,R/W		00000111 _B
0000BE _H	Interrupt Control Register 14	ICR14	W,R/W		00000111 _B
0000BF _H	Interrupt Control Register 15	ICR15	W,R/W		00000111 _B
0000C0 _H	D/A Converter Data 0	DAT0	R/W	D/A Converter	XXXXXXXX _B
0000C1 _H	D/A Converter Data 1	DAT1	R/W		XXXXXXXX _B
0000C2 _H	D/A Control 0	DACR0	R/W		XXXXXXXX0 _B
0000C3 _H	D/A Control 1	DACR1	R/W		XXXXXXXX0 _B

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Address	Register	Abbreviation	Access	Resource name	Initial value
007900 _H	Reload Register L0	PRL0	R/W	16-bit PPG 0/1	XXXXXXXX _B
007901 _H	Reload Register H0	PRLH0	R/W		XXXXXXXX _B
007902 _H	Reload Register L1	PRL1	R/W		XXXXXXXX _B
007903 _H	Reload Register H1	PRLH1	R/W		XXXXXXXX _B
007904 _H	Reload Register L2	PRL2	R/W	16-bit PPG 2/3	XXXXXXXX _B
007905 _H	Reload Register H2	PRLH2	R/W		XXXXXXXX _B
007906 _H	Reload Register L3	PRL3	R/W		XXXXXXXX _B
007907 _H	Reload Register H3	PRLH3	R/W		XXXXXXXX _B
007908 _H	Reload Register L4	PRL4	R/W	16-bit PPG 4/5	XXXXXXXX _B
007909 _H	Reload Register H4	PRLH4	R/W		XXXXXXXX _B
00790A _H	Reload Register L5	PRL5	R/W		XXXXXXXX _B
00790B _H	Reload Register H5	PRLH5	R/W		XXXXXXXX _B
00790C _H	Reload Register L6	PRL6	R/W	16-bit PPG 6/7	XXXXXXXX _B
00790D _H	Reload Register H6	PRLH6	R/W		XXXXXXXX _B
00790E _H	Reload Register L7	PRL7	R/W		XXXXXXXX _B
00790F _H	Reload Register H7	PRLH7	R/W		XXXXXXXX _B
007910 _H	Reload Register L8	PRL8	R/W	16-bit PPG 8/9	XXXXXXXX _B
007911 _H	Reload Register H8	PRLH8	R/W		XXXXXXXX _B
007912 _H	Reload Register L9	PRL9	R/W		XXXXXXXX _B
007913 _H	Reload Register H9	PRLH9	R/W		XXXXXXXX _B
007914 _H	Reload Register LA	PRLA	R/W	16-bit PPG A/B	XXXXXXXX _B
007915 _H	Reload Register HA	PRLHA	R/W		XXXXXXXX _B
007916 _H	Reload Register LB	PRLB	R/W		XXXXXXXX _B
007917 _H	Reload Register HB	PRLHB	R/W		XXXXXXXX _B
007918 _H	Reload Register LC	PRLC	R/W	16-bit PPG C/D	XXXXXXXX _B
007919 _H	Reload Register HC	PRLHC	R/W		XXXXXXXX _B
00791A _H	Reload Register LD	PRLD	R/W		XXXXXXXX _B
00791B _H	Reload Register HD	PRLHD	R/W		XXXXXXXX _B
00791C _H	Reload Register LE	PRLLE	R/W	16-bit PPG E/F	XXXXXXXX _B
00791D _H	Reload Register HE	PRLHE	R/W		XXXXXXXX _B
00791E _H	Reload Register LF	PRLLF	R/W		XXXXXXXX _B
00791F _H	Reload Register HF	PRLHF	R/W		XXXXXXXX _B
007920 _H	Input Capture 0	IPCP0	R	Input Capture 0/1	XXXXXXXX _B
007921 _H	Input Capture 0	IPCP0	R		XXXXXXXX _B
007922 _H	Input Capture 1	IPCP1	R		XXXXXXXX _B
007923 _H	Input Capture 1	IPCP1	R		XXXXXXXX _B

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List of Control Registers (2)

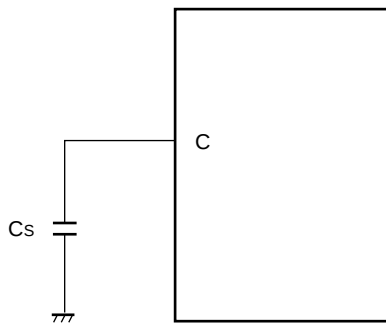
Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
007B00 _H	007D00 _H	Control Status Register	CSR	R/W, W R/W, R	0XXXX0X1 _B 00XXX000 _B
007B01 _H	007D01 _H				
007B02 _H	007D02 _H	Last Event Indicator Register	LEIR	R/W	000X0000 _B XXXXXXXX _B
007B03 _H	007D03 _H				
007B04 _H	007D04 _H	Receive And Transmit Error Counter	RTEC	R	00000000 _B 00000000 _B
007B05 _H	007D05 _H				
007B06 _H	007D06 _H	Bit Timing Register	BTR	R/W	11111111 _B X1111111 _B
007B07 _H	007D07 _H				
007B08 _H	007D08 _H	IDE Register	IDER	R/W	XXXXXXXX _B XXXXXXXX _B
007B09 _H	007D09 _H				
007B0A _H	007D0A _H	Transmit RTR Register	TRTRR	R/W	00000000 _B 00000000 _B
007B0B _H	007D0B _H				
007B0C _H	007D0C _H	Remote Frame Receive Waiting Register	RFWTR	R/W	XXXXXXXX _B XXXXXXXX _B
007B0D _H	007D0D _H				
007B0E _H	007D0E _H	Transmit Interrupt Enable Register	TIER	R/W	00000000 _B 00000000 _B
007B0F _H	007D0F _H				
007B10 _H	007D10 _H	Acceptance Mask Select Register	AMSR	R/W	XXXXXXXX _B XXXXXXXX _B
007B11 _H	007D11 _H				
007B12 _H	007D12 _H				XXXXXXXX _B XXXXXXXX _B
007B13 _H	007D13 _H				
007B14 _H	007D14 _H	Acceptance Mask Register 0	AMR0	R/W	XXXXXXXX _B XXXXXXXX _B
007B15 _H	007D15 _H				
007B16 _H	007D16 _H				XXXXXXXX _B XXXXXXXX _B
007B17 _H	007D17 _H				
007B18 _H	007D18 _H	Acceptance Mask Register 1	AMR1	R/W	XXXXXXXX _B XXXXXXXX _B
007B19 _H	007D19 _H				
007B1A _H	007D1A _H				XXXXXXXX _B XXXXXXXX _B
007B1B _H	007D1B _H				

11.2 Recommended Operating Conditions

($V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.0	5.0	5.5	V	Under normal operation
		3.5	5.0	5.5	V	Under normal operation, when not using the A/D converter and not Flash programming.
		4.5	5.0	5.5	V	When External bus is used.
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smoothing capacitor	C_S	0.1	—	1.0	μF	Use a ceramic capacitor or capacitor of better AC characteristics. Capacitor at the V_{CC} should be greater than this capacitor.
Operating temperature	T_A	-40	—	+105	$^{\circ}\text{C}$	

C Pin Connection Diagram



WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

11.4 AC Characteristics

11.4.1 Clock Timing

($T_A = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = AV_{SS} = 0\text{ V}$)

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	f_C	X0, X1	3	—	16	MHz	When using an oscillation circuit
			4	—	16	MHz	PLL multiplied by 1 When using an oscillation circuit
			4	—	12	MHz	PLL multiplied by 2 When using an oscillation circuit
			4	—	8	MHz	PLL multiplied by 3 When using an oscillation circuit
			4	—	6	MHz	PLL multiplied by 4 When using an oscillation circuit
			—	—	4	MHz	PLL multiplied by 6 When using an oscillation circuit
			3	—	24	MHz	When using an external clock*
	f_{CL}	X0A, X1A	—	32.768	100	kHz	
Clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	When using an oscillation circuit
		X0, X1	41.67	—	333	ns	When using an external clock
	t_{CYLL}	X0A, X1A	10	30.5	—	μs	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30% to 70%.
	P_{WHL}, P_{WLL}	X0A	5	15.2	—	μs	
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using external clock
Internal operating clock frequency (machine clock)	f_{CP}	—	1.5	—	24	MHz	When using main clock
	f_{CPL}	—	—	8.192	50	kHz	When using sub clock
Internal operating clock cycle time (machine clock)	t_{CP}	—	41.67	—	666	ns	When using main clock
	t_{CPL}	—	20	122.1	—	μs	When using sub clock

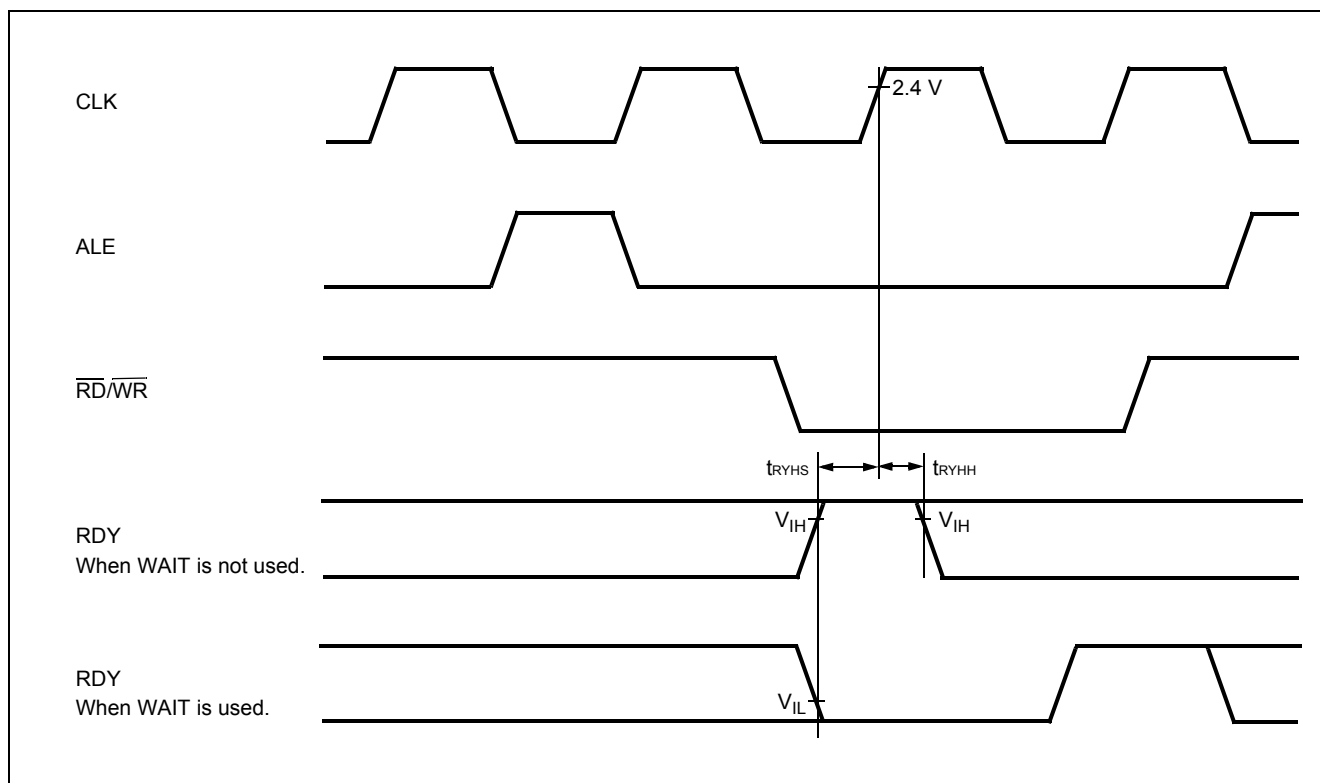
* : When selecting the PLL clock, the range of clock frequency is limited. Use this product within the range as mentioned in "Relation between the external clock frequency and machine clock frequency".

11.4.7 Ready Input Timing

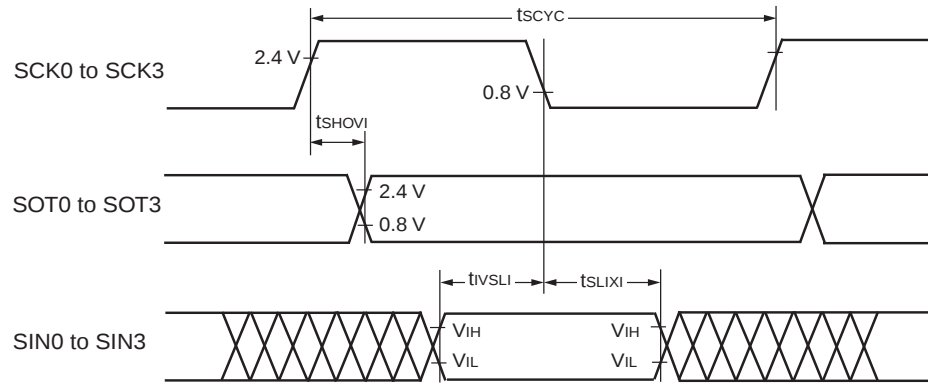
($T_A = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $f_{CP} \leq 24\text{ MHz}$)

Parameter	Symbol	Pin	Test Condition	Rated Value		Unit	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	$f_{CP} = 16\text{ MHz}$
				32	—	ns	$f_{CP} = 24\text{ MHz}$
RDY hold time	t_{RYHH}	RDY		0	—	ns	

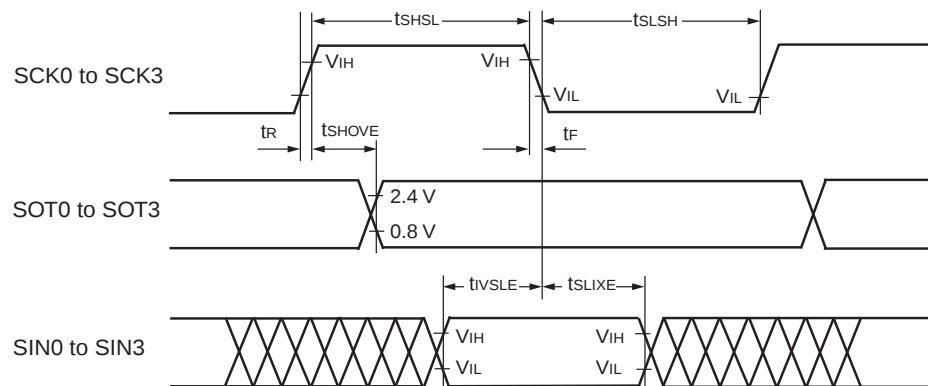
Note: : If the RDY setup time is insufficient, use the auto-ready function.



• Internal Shift Clock Mode



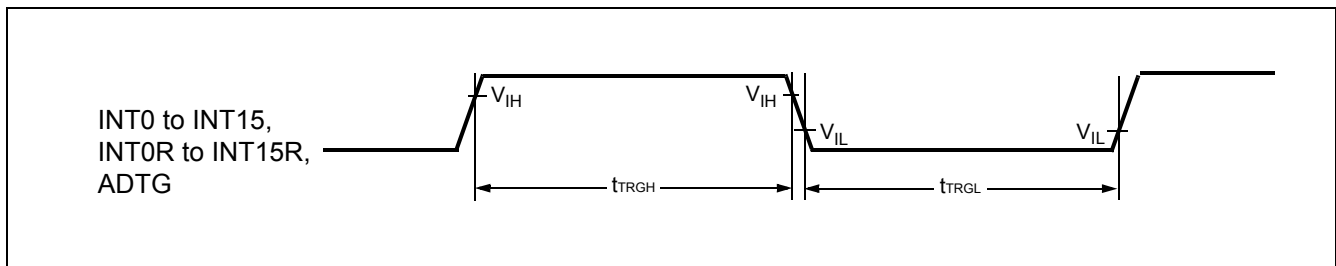
• External Shift Clock Mode



11.4.10 Trigger Input Timing

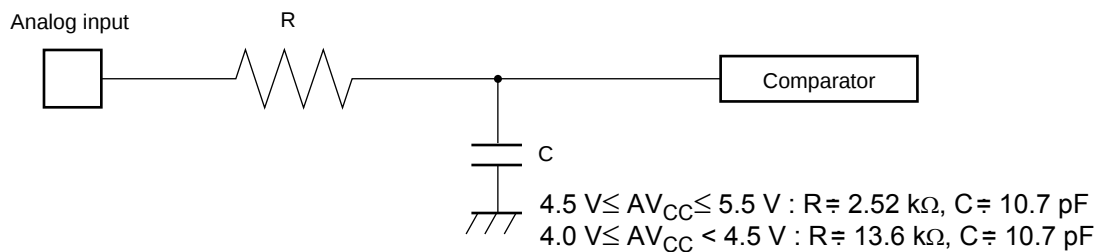
($T_A = -40^{\circ}\text{C}$ to $+105^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $f_{CP} \leq 24\text{ MHz}$, $V_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Pin	Condition	Value		Unit
				Min	Max	
Input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT15, INT0R to INT15R, ADTG	—	$5 t_{CP}$	—	ns



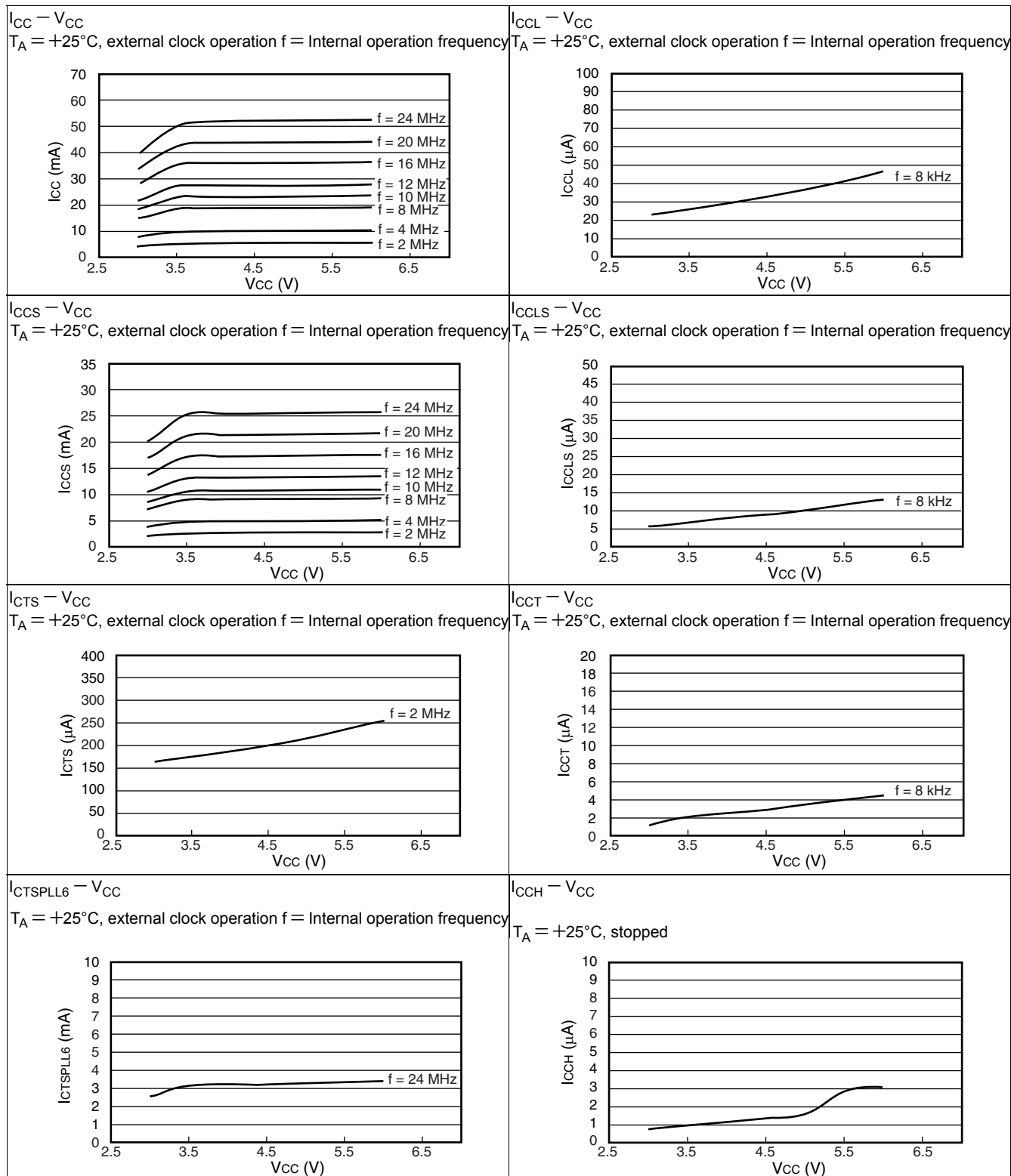
If the output impedance of the external circuit is too high, a sampling period for an analog voltage may be insufficient.

• Analog input circuit model



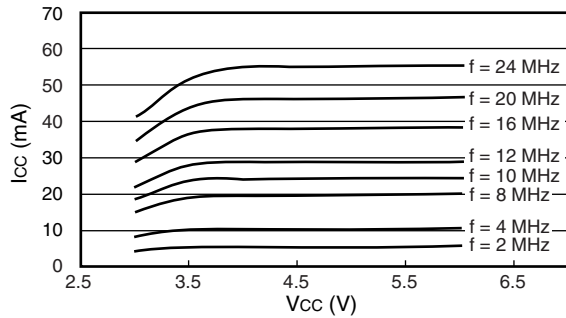
Note: : Use the values in the figure only as a guideline.

■ MB90F347E, MB90F347ES, MB90F347CE, MB90F347CES

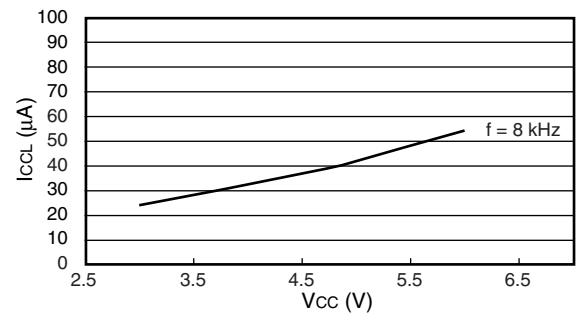


■ MB90346E, MB90346ES, MB90346CE, MB90346CES

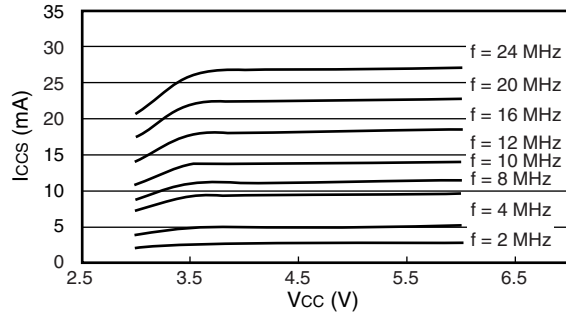
$I_{CC} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



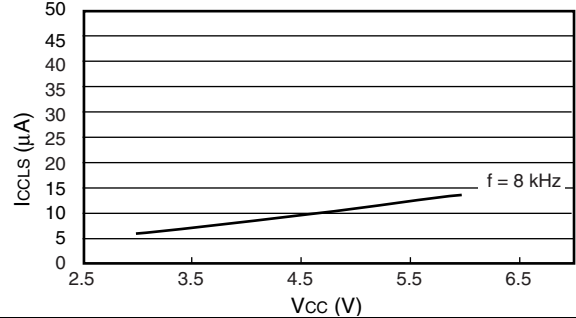
$I_{CCL} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



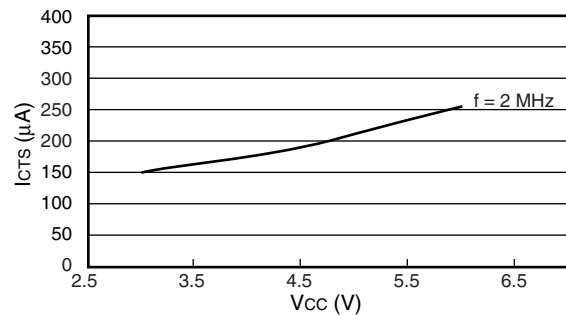
$I_{CCS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



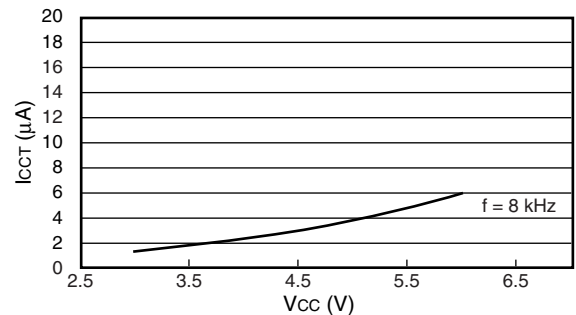
$I_{CCLS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



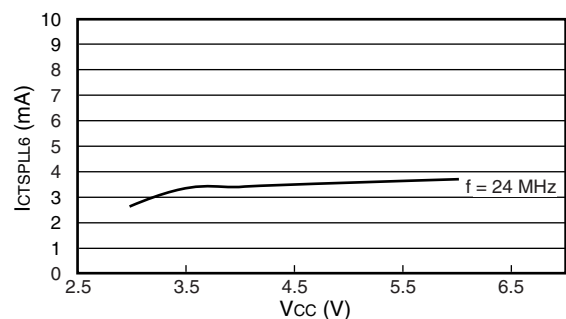
$I_{CTS} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



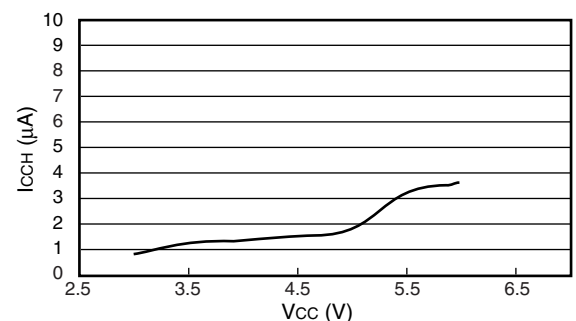
$I_{CCT} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



$I_{CTSPLL6} - V_{CC}$
 $T_A = +25^\circ\text{C}$, external clock operation $f =$ Internal operation frequency



$I_{CCH} - V_{CC}$
 $T_A = +25^\circ\text{C}$, stopped



Part number	Package	Remarks
MB90F347EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F347ESPF		
MB90F347CEPF		
MB90F347CESPF		
MB90F347EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F347ESPMC		
MB90F347CEPMC		
MB90F347CESPMC		
MB90F349EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90F349ESPF		
MB90F349CEPF		
MB90F349CESPF		
MB90F349EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90F349ESPMC		
MB90F349CEPMC		
MB90F349CESPMC		
MB90341EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90341ESPF		
MB90341CEPF		
MB90341CESPF		
MB90341EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90341ESPMC		
MB90341CEPMC		
MB90341CESPMC		
MB90342EPF	100-pin plastic QFP (FPT-100P-M06)	
MB90342ESPF		
MB90342CEPF		
MB90342CESPF		
MB90342EPMC	100-pin plastic LQFP (FPT-100P-M20)	
MB90342ESPMC		
MB90342CEPMC		
MB90342CESPMC		

(Continued)

15. Major Changes

Spanision Publication Number: DS07-13747-4E

Page	Section	Change Results
—	—	Deleted the part numbers; MB90F343E(S), MB90F343CE(S)
51	Electrical Characteristics Absolute Maximum Ratings	Added “*6” in remark for “L” level maximum output current and “H” level maximum output current. Added “*7” in remark for “L” level average output current and “H” level average output current. Added “*8” in remark for “L” level average overall output current and “H” level average overall output current.
52		Added as follows. “*6: The maximum output current is defined as the peak value of the current of any one of the corresponding pins.” “*7: The average output current is defined as the value of the average current flowing over 100 ms at any one of the corresponding pins.” “*8: The average total output current is defined as the value of the average current flowing over 100 ms at all of the corresponding pins.”

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90340E Series F2MC-16LX 16-bit Microcontroller Datasheet Document Number: 002-04498				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	AKIH	08/23/2010	Migrated to Cypress and assigned document number 002-04498. No change to document contents or format.
*A	5221535	AKIH	05/04/2016	Updated to Cypress template